

Outline of Initial Listing Issue

Company Name	O.B.System Inc.
Scheduled Listing Date	Jun. 21, 2023
Market Section	Standard Market
Current Listed Market	N/A
Name and Title of Representative	TOYODA Toshio, President
Address of Main Office	2-3-7 Hiranomachi, Osaka Chuo-ku, Osaka 541-0046 Tel. +81-6-6228-3411
(Closest Point of Contact)	(Same as above)
Home Page	https://www.obs.co.jp/
Date of Incorporation	Aug. 25, 1972
Description of Business	System integration services business with four service lines: Finance, Industry and Distribution, Social and Public services, and IT innovation
Category of Industry / Code	Information & Communication / 5576(ISIN JP3173250006)
Authorized Total No. of Shares to be Issued	8,000,000 shares
No. of Issued Shares	2,220,000 shares (As of May 19, 2023)
No. of Issued Shares (incl. treasury shares) at the Time of Listing	2,277,000 shares (Note) The number includes newly issued shares issued through the public offering.
Capital	JPY 74,750 thousand (As of May 19, 2023)
No. of Shares per Share Unit	100 shares
Business Year	From Apr. 1 to Mar. 31 of the following year
General Shareholders Meeting	Within 3 months after the end of the business year
Record Date	Mar. 31
Record Date of Surplus Dividend	Sep. 30 and Mar. 31
Transfer Agent	Mitsubishi UFJ Trust and Banking Corporation
Auditor	Crowe Toyo & Co.
Managing Trading Participant	SMBC Nikko Securities Inc.

(Reference Translation)

<Overview of Public Offering / Secondary Offering >

Public Offering /	Public Offering (Newly Issued Shares)	57,000 shares
Secondary Offering	Public Offering (Treasury Shares)	143,000 shares
	Secondary Offering	400,000 shares
	(Placement Underwritten and Purchased by Principal Underwriting Participants)	
	Secondary Offering	90,000 shares
	(Placement by over-allotment scheme)	
Original Share Offerers	OBIC Co., Ltd.	140,000 shares
	Hitachi Solutions, Ltd.	120,000 shares
	YAMADA Takashi	85,000 shares
	Others	55,000 shares
Offering Price	Book-building method	
Determination Method		
Provisional Conditions	Jun. 5, 2023	
Determination Date		
Book-building Period	Jun. 6, 2023 to Jun. 12, 2023	
Offering Price	Jun. 13, 2023	
Determination Date		
Subscription Period	Jun. 14, 2023 to Jun. 19, 2023	
Payment Date	Jun. 20, 2023	
Settlement Date	Jun. 21, 2023	
Principal Underwriting Participants	SMBC Nikko Securities Inc. Mitsubishi UFJ Morgan Stanley Securities Co., Ltd. SBI SECURITIES Co.,Ltd. IwaiCosmo Securities Co.,Ltd. Monex, Inc. MATSUI SECURITIES CO.,LTD. Akatsuki Securities, Inc.	

(Note 1) Tokyo Stock Exchange, Inc. approves new listings based on the results of the examination by Japan Exchange Regulation.

(Note 2) The “Initial Listing Application Securities Report (Part I)” (only in Japanese) of the company is available on the JPX official website. Please refer to such release for details.